

# AGENDA

## *Electronic Components, Assemblies & Materials Association*

Engineering Committee on Resistive Devices (P1)

Tuesday, April 25, 2006

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**Ft. Lauderdale, FL**

### P-1 Resistor Committee

#### 1.0 Introductions

#### 2.0 Committee Organization and Procedures

- 2.1 Membership
- 2.2 Approval of Agenda
- 2.3 Approval of October 2005 Meeting Minutes
- 2.4 Correspondence
- 2.5 Review of Committee's Scope – "All types of resistive components regardless of technology. Includes composition, film, wirewound, Thermistors, attenuators, and chip resistors and exclude Integrated Passive Devices."

#### 3.0 Old Business

- 3.1 Review & resolve comments, from letter ballot, for PN5090 (EIA-886 "Thick Film Resistor Array"). If comments are resolved the group will be voting to approve guideline as official specification with ECA in Spring 2006.
- 3.2 Review & resolve comments, from letter ballot, for PN5091 (EIA-887 "Thin Film Network"). If comments are resolved the group will be voting to approve guideline as official specification with ECA in Spring 2006.
- 3.3 Review & resolve comments, from letter ballot, for PN5093 ("Thin Film on Ceramic Array"). If comments are resolved the group will be voting to approve guideline as official specification with ECA in Spring 2006.
- 3.4 Review any additions to PDP-100
- 3.5 Five year document review
  - CB15
  - EIA-452 "Fixed Film Resistors High Resistance/High Voltage"

#### 4.0 New Business

- 4.1 – J-STD-020 (MSL levels for IPD's) are there any issues?
- 4.2 – ECA Message Board access

#### 5.0 Next Meeting

- 5.1 – Fall meeting will be held in Reno, NV

#### 6.0 Adjournment

